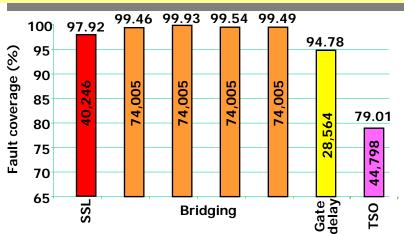
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Test and Diagnosis of ICs



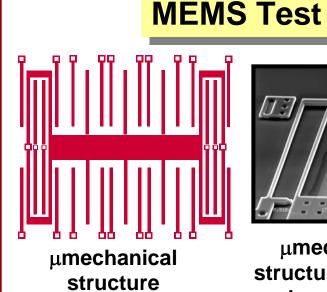
Test grading with FAult Tuple SIMulator

- Defect modeling
- Test methodology development
- CAD tool development
- Defect diagnosis



Courses:

- 18-240: Fundamentals of Computer Engineering
- 18-340: Digital Computation
- 18-441: Verification of Computer Hardware Systems
- 18-765: Digital Systems Testing and Testable Design



μmechanical structure affected by a defect

- Defect modeling
- Built-in self test (BIST) design
- Test methodology development



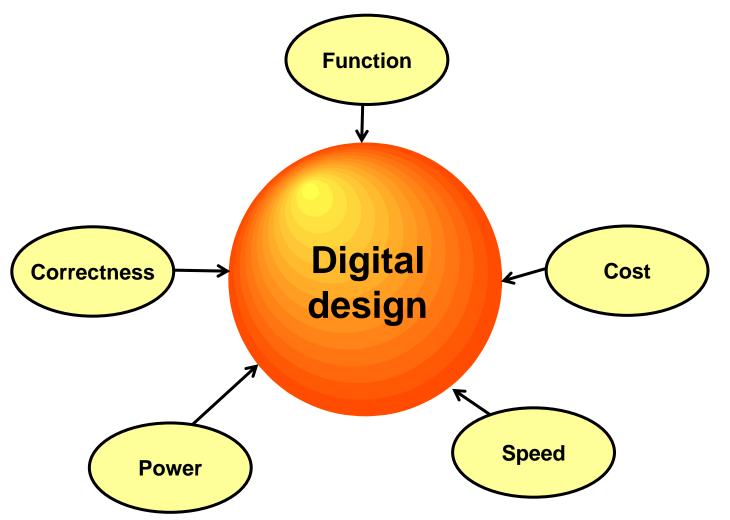
Digital Circuit Design

Emerging Trends in Electrical and Computer Engineering Shawn Blanton Fall 2004 blanton@ece.cmu.edu





Components of Digital Design

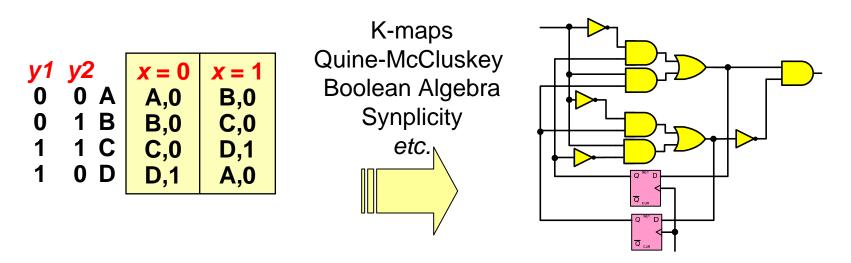




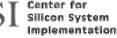


Function

- When we design a circuit to do a particular function, we assume we have primitive gates like AND, OR, *etc*.
- So we build bigger things from smaller things.
- And we have systematic methods (*i.e.*, CAD tools) for building bigger things.

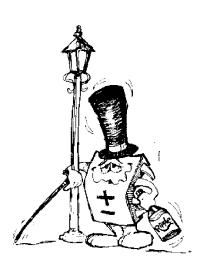






Function cont...

- But what if you wanted to build a fast, 64-bit adder?
- What about using a ripple-carry adder?
- Systematic techniques cannot handle some things we want to build.



How many rows are in the truth table for a 64-bit adder?

0 1 1 0 1 1 0 1

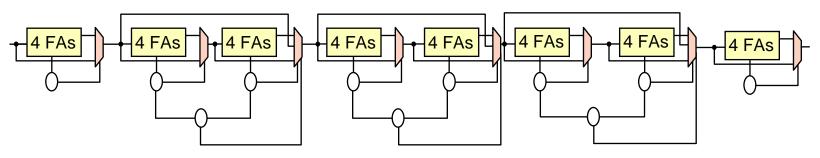




Function cont...

- There are many known adder architectures.
- To learn how to design an adder for your given application, you must "see" these adders and understand how they work.

32-bit carry-skip adder



• The same is true for other *data-processing* circuits: multipliers, dividers, filters, *etc*.





Customized Floating Point Unit

64-bit floating point



13-bit custom floating



Courtesy of Prof. Rob Rutebnar

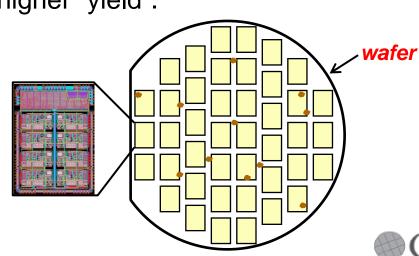




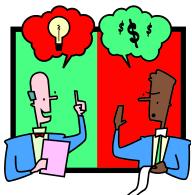
Cost **\$\$\$**

- Many ideas you may have are likely possible.
- But as engineers, it must be possible at a reasonable cost.
- One type of cost has to do with design size.
- Ideally, you want a circuit implementation to take very little "area" for a number of reasons:
 - Small circuits means more can fit onto a "wafer".
 - Small circuits have a higher "yield".

Yield = good chips Total chips







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- The number of gates available in the same area is doubling every 18 months ("Moore's Law").
- Designer productivity is not increasing at the same rate. This leads to the "design gap".
- Solution: Better CAD tools for design and analysis!





Speed

- Your new adder design may "add", but does it add fast enough?
- Digital design requires you to understand how to accurately predict the speed of your circuit.
- Lots of factors affect speed:
 - Design structure
 - Fabrication technology
 - Environment
- Actually, you cannot really predict speed that accurately.





3.1GHz



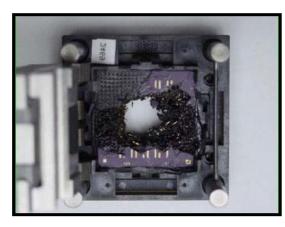


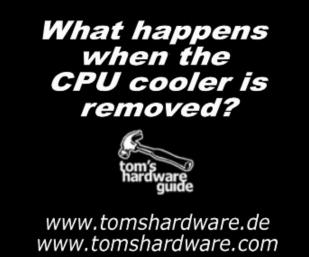




Power

- Power is now the number one challenge for digital circuit designers!
- Why? Many electronic systems are portable.
- Low power means longer battery life.
- High power generates lots of heat so designs
 must be cooled.









Correctness

- Designers make mistakes.
- How do you find errors in a design?
- In 18-240, your method for finding mistakes is either *ad hoc* or impractical.
- You need systematic approaches that utilize CAD tools that include simulators, equivalence checkers, model checkers, *etc*.
- Big companies still make mistakes. Intel made an error designing a divider circuit. It cost Intel \$470M.





Correctness cont...

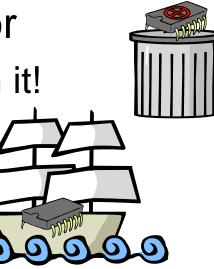
- Manufacturing is not perfect.
- How do you find imperfections in the fabricated design?
- You must test each and every chip to ensure it works.





Test and Diagnosis

- Test is a binary endeavor
 - Chip doesn't work trash it!
 - Chip works ship it!



- Diagnosis
 - Why doesn't the chip work???
 - Required for silicon debug, process tuning, etc.





What do you test for?

- Test the chip function?
 - Portions of the chip are tested this way.
 - Too costly however for the entire chip.
- It is more cost-effective to test for the things that can go wrong.





What can go wrong?

One or more defects can occur!

- A defect can be extra or missing material or changes in material properties
 - Defects can affect wires and vias
 - Defects can affect transistors
- Defect-based test is impractical
 - Too many possible locations (billions)
 - Too many different types (N × billions)
- To keep test manageable, abstraction is necessary





Defect Abstraction

- Abstraction involves
 - Moving from physical level to higher level
 - Reducing number of defects
 - Simplifying defect behavior
- Defect abstraction = fault model



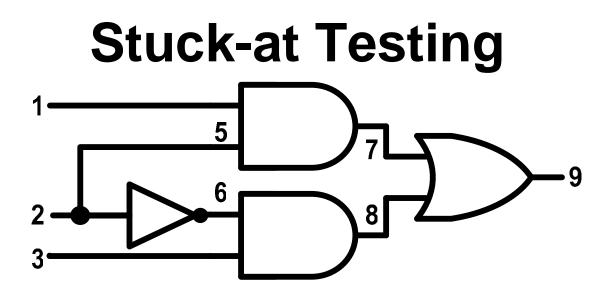


SSL Fault Model

- The most widely-use abstraction is single stuck-line (SSL) fault model.
- First published use was for vacuum tube test in 1957 by R. Eldred.
- SSL fault model properties:
 - a gate-level model
 - assumes gates are unaffected
 - only a single logic line can be faulty
 - faulty line is permanently stuck-at 0 or 1





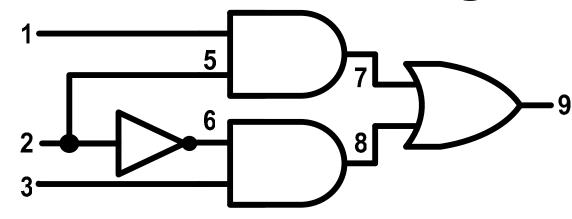


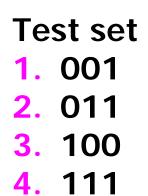
- The circuit above has 9 logical lines.
- Each line is susceptible to either a stuck-at-0 or stuck-at-1 fault, for a total of 18 faults.
- Must find tests that distinguish the 18 faulty circuits from the "good" circuit.





Stuck-at Testing cont'd





123	9	9/1	7/1	2/1	9/0	7/0	5/1	8/0	1/1	2/0	3/1	6/1
000	0	1	1	0	0	0	0	0	0	0	1	0
001	1	1	1	0	0	1	1	0	1	1	1	1
010	0	1	1	0	0	0	0	0	1	0	0	0
011	0	1	1	0	0	0	0	0	1	1	0	1
100	0	1	1	1	0	0	1	0	0	0	1	0
101	1	1	1	1	0	1	1	0	1	1	1	1
110	1	1	1	1	0	0	1	1	1	0	1	1
111	1	1	1	1	0	0	1	1	1	1	1	1





Digital Design Courses

Learn more by taking various courses in digital design.

